



## N-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY     |  |                                    |                       |  |  |
|---------------------|--|------------------------------------|-----------------------|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$ (Max.) | I <sub>D</sub> (A) <sup>a, g</sup> | Q <sub>g</sub> (Typ.) |  |  |
| 30                  | 0.0043 at V <sub>GS</sub> = 10 V       | 25                                 | 13.6 nC               |  |  |
|                     | 0.0060 at V <sub>GS</sub> = 4.5 V      | 25                                 | 13.0110               |  |  |

# PowerPAK® SO-8 **Bottom View**

#### **Ordering Information:** SiRA12DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

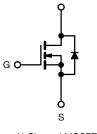
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Gen IV Power MOSFET
- 100 %  $R_{\alpha}$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

# COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- High Power Density DC/DC
- Synchronous Rectification
- VRMs and Embedded DC/DC



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS                            | <b>S</b> (T <sub>A</sub> = 25 °C, unle | ess otherwise no | oted)                 |    |  |
|---|--|------------------|-----------------------|----|--|
| Parameter   | Symbol                                 | Limit            | Unit                  |    |  |
| Drain-Source Voltage                                | $V_{DS}$                               | 30               | V                     |    |  |
| Gate-Source Voltage                                 | $V_{GS}$                               | + 20, - 16       | v                     |    |  |
|   | T <sub>C</sub> = 25 °C                 |                  | 25 <sup>g</sup>       |    |  |
| Continuous Drain Current (T <sub>.I</sub> = 150 °C) | T <sub>C</sub> = 70 °C                 | I_               | 25 <sup>g</sup>       |    |  |
| Continuous Brain Guirent (1) = 130 °C)              | T <sub>A</sub> = 25 °C                 | I <sub>D</sub>   | 25 <sup>b, c, g</sup> |    |  |
|   | T <sub>A</sub> = 70 °C                 |                  | 20 <sup>b, c</sup>    | Α  |  |
| Pulsed Drain Current (t = 300 μs)                   | I <sub>DM</sub>                        | 80               | 7                     |    |  |
| Continuous Source-Drain Diode Current               | T <sub>C</sub> = 25 °C                 | I <sub>S</sub>   | 25 <sup>g</sup>       |    |  |
| Continuous Source-Drain Diode Guirent               | T <sub>A</sub> = 25 °C                 | 'S               | 3.8 <sup>b, c</sup>   |    |  |
| Single Pulse Avalanche Current                      | L = 0.1 mH                             | I <sub>AS</sub>  | 15                    |    |  |
| Single Pulse Avalanche Energy                       | L = 0.1 IIII1                          | E <sub>AS</sub>  | 11                    | mJ |  |
|   | T <sub>C</sub> = 25 °C                 |                  | 31                    |    |  |
| Maximum Power Dissipation                           | T <sub>C</sub> = 70 °C                 | P <sub>D</sub>   | 20                    | w  |  |
| Maximum Fower Dissipation                           | T <sub>A</sub> = 25 °C                 | ' D              | 4.5 <sup>b, c</sup>   |    |  |
|   | T <sub>A</sub> = 70 °C                 |                  | 2.9 <sup>b, c</sup>   |    |  |
| Operating Junction and Storage Temperature Ra       | T <sub>J</sub> , T <sub>stg</sub>      | - 55 to 150      | °C                    |    |  |
| Soldering Recommendations (Peak Temperature         |  | 260              | $\exists$             |    |  |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |      |      |  |
|---|--------------|-------------------|---------|------|------|--|
| Parameter                                   | Symbol       | Typical           | Maximum | Unit |      |  |
| Maximum Junction-to-Ambient <sup>b, f</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 25      | 28   | °C/W |  |
| Maximum Junction-to-Case (Drain)            | Steady State | $R_{thJC}$        | 3.2     | 4    |      |  |

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.
- g. Package limited.

## Vishay Siliconix



| <b>SPECIFICATIONS</b> ( $T_J = 25$ °C,        | unless othe                                     | rwise noted)   |      |        |        |       |  |
|---|---|--|------|--------|--------|-------|--|
| Parameter                                     | Symbol  | Test Conditions  | Min. | Тур.   | Max.   | Unit  |  |
| Static  |   |  |      |        |        |       |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>                                 | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                            | 30   |        |        | V     |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$ $\Delta V_{GS(th)}/T_{J}$ | I <sub>D</sub> = 250 μA  |      | 16     |        | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   |   |  |      | - 5    |        |       |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>                             | $V_{DS} = V_{GS}, I_D = 250 \mu A$                                       | 1.1  |        | 2.2    | V     |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>                                | $V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$                      |      |        | ± 100  | nA    |  |
| Zone Oote Wellene Busin Oursel                | ,   | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$                            |      |        | 1      | μΑ    |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>                                | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 ^{\circ}\text{C}$ |      |        | 10     |       |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>                              | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                          | 25   |        |        | Α     |  |
|   |   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A                            |      | 0.0032 | 0.0043 | Ω     |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>                             | $V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$                              |      | 0.0044 | 0.0060 |       |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>                                 | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A                            |      | 51     |        | S     |  |
| Dynamic <sup>b</sup>                          |   |  | •    | •      | •      |       |  |
| Input Capacitance                             | C <sub>iss</sub>                                |  |      | 2070   |        | pF    |  |
| Output Capacitance                            | C <sub>oss</sub>                                | V 45VV 6V/ 4VV   |      | 600    |        |       |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>                                | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$         |      | 51     |        |       |  |
| C <sub>rss</sub> /C <sub>iss</sub> Ratio      |   |  |      | 0.025  | 0.050  |       |  |
| T. 10 . 0                                     | 0   | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A    |      | 29.5   | 45     | nC    |  |
| Total Gate Charge                             | $Q_g$   | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A   |      | 13.6   | 21     |       |  |
| Gate-Source Charge                            | Q <sub>gs</sub>                                 |  |      | 5.2    |        |       |  |
| Gate-Drain Charge                             | $Q_{gd}$  |  |      | 2.6    |        |       |  |
| Output Charge                                 | Q <sub>oss</sub>                                | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V                            |      | 16     |        |       |  |
| Gate Resistance                               | $R_{g}$   | f = 1 MHz  | 0.3  | 1.7    | 3.4    | Ω     |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>                              |  |      | 10     | 20     |       |  |
| Rise Time                                     | t <sub>r</sub>                                  | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$                                    |      | 10     | 20     |       |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>                             | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$         |      | 25     | 50     |       |  |
| Fall Time                                     | t <sub>f</sub>                                  |  |      | 10     | 20     |       |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>                              |  |      | 20     | 40     | ns    |  |
| Rise Time                                     | t <sub>r</sub>                                  | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$                                    |      | 15     | 30     |       |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>                             | $I_D\cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$                   |      | 22     | 45     |       |  |
| Fall Time                                     | t <sub>f</sub>                                  |  |      | 10     | 20     |       |  |
| Drain-Source Body Diode Characteristic        | ll ll   |  |      |        |        |       |  |
| Continuous Source-Drain Diode Current         | Is  | T <sub>C</sub> = 25 °C   |      |        | 25     |       |  |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>                                 |  |      |        | 80     | A     |  |
| Body Diode Voltage                            | V <sub>SD</sub>                                 | I <sub>S</sub> = 10 A  |      | 0.86   | 1.2    | V     |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>                                 |  | 1    | 27     | 55     | ns    |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>                                 | $I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s},$                 |      | 15     | 30     | nC    |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>                                  | T <sub>J</sub> = 25 °C   |      | 13     |        | - ns  |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>                                  |  |      | 14     |        |       |  |
| <u> </u>                                      | · · ·   |  | 1    | 1      | L      |       |  |

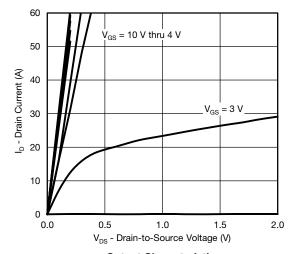
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

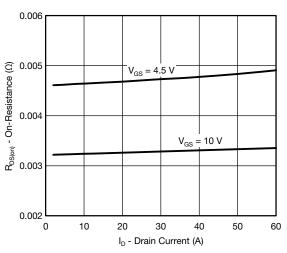
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



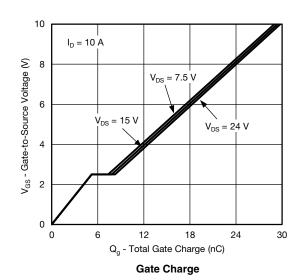
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

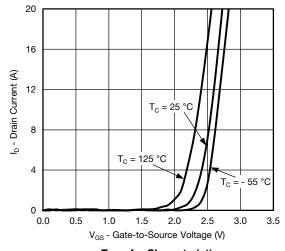


#### **Output Characteristics**

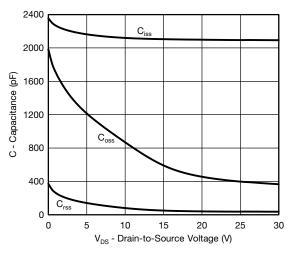


On-Resistance vs. Drain Current

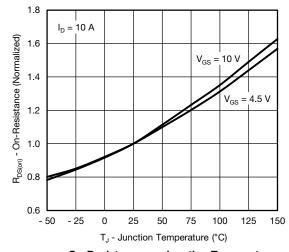




**Transfer Characteristics** 



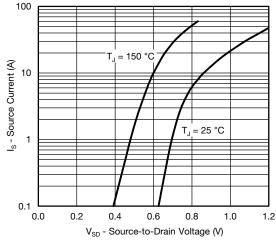
Capacitance

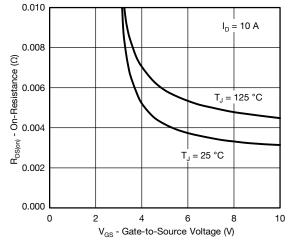


On-Resistance vs. Junction Temperature

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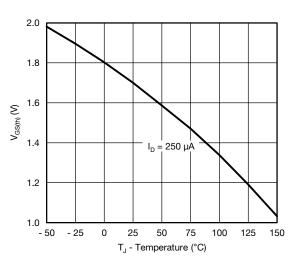
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

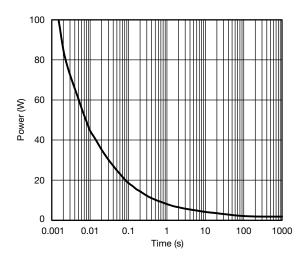




Source-Drain Diode Forward Voltage

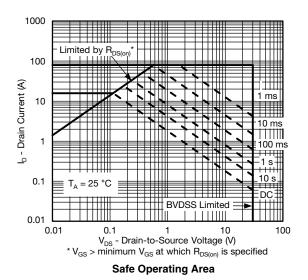
On-Resistance vs. Gate-to-Source Voltage





Threshold Voltage

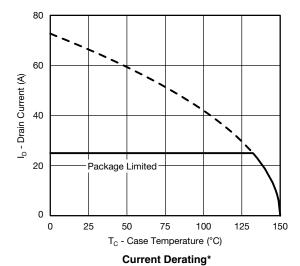
Single Pulse Power, Junction-to-Ambient

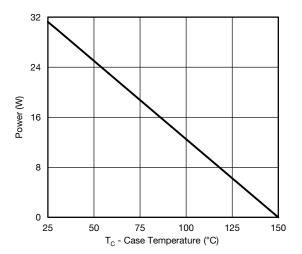






### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



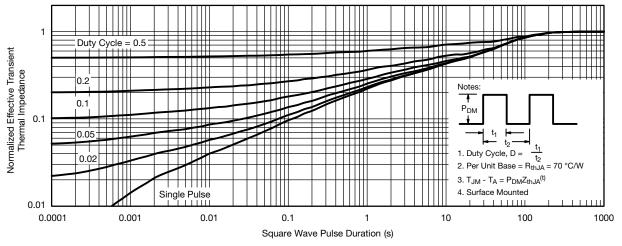


Power, Junction-to-Case

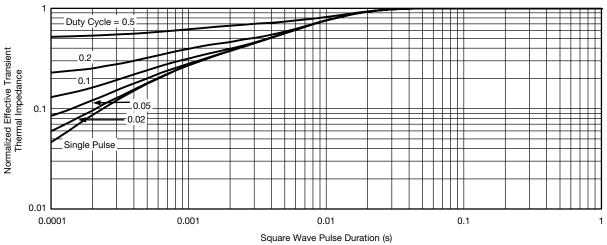
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63786.



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